Center for Efficient Exascale Discretizations (CEED)

Tzanio Kolev (LLNL) CEED PI



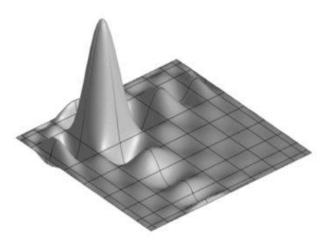




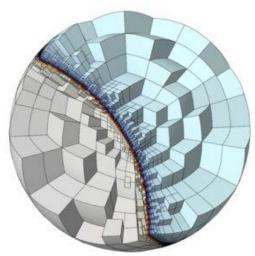
- PDE-based simulations on unstructured grids
- high-order and spectral finite elements

✓ any order space on any order mesh ✓ curved meshes,

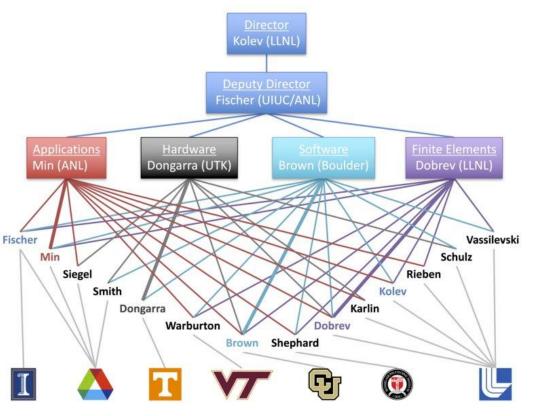
✓ unstructured AMR ✓ optimized low-order support



10th order basis function



non-conforming AMR, 2nd order mesh



ceed.exascaleproject.org

2 Labs, 5 Universities, 30+ researchers

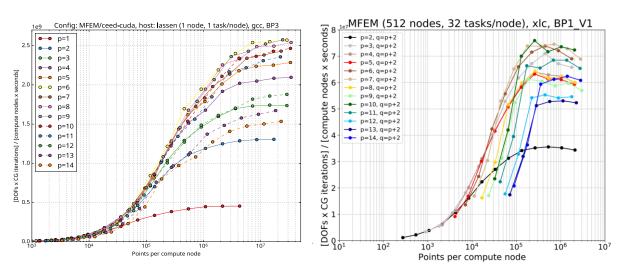


Why High-Order?



Better HPC

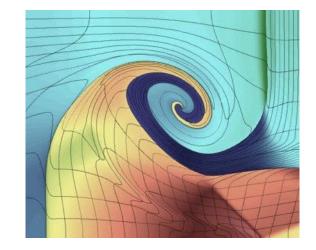
- ✓ multiple levels of parallelism
- ✓ inter-device parallel sparse linear algebra
- ✓ on-device dense linear algebra
- \checkmark batched tensor contractions
- ✓ FLOPs/bytes increase with order

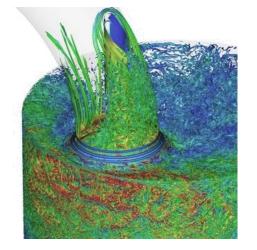


FEM benchmark problems on GPU (left) and CPU (right): high-order kernels have up to 5x better performance for same #dofs

Better science

- \checkmark naturally support unstructured and curvilinear grids
- \checkmark increased accuracy for smooth problems
- \checkmark sub-element modeling for problems with shocks
- ✓ better symmetry, conservation, robustness, ...
- ✓ many apps: compressible flow, AM, fusion, ...





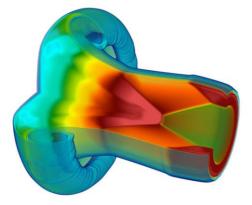
8th order Lagrangian shock hydro (MFEM)

6th order DNS turbulence (Nek)

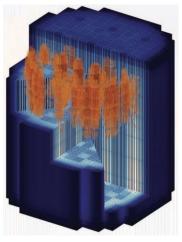


CEED Target Applications

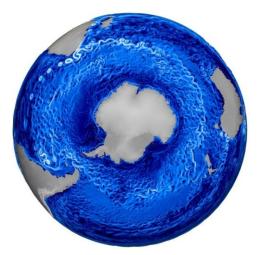




Compressible flow (MARBL)



Modular Nuclear Reactors (ExaSMR)



Climate (E3SM)



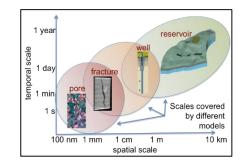
Wind Energy (ExaWind)



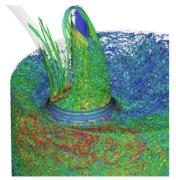
Urban systems (Urban)



Additive Manufacturing (ExaAM) Magnetic Fusion (WDMApp)



Subsurface (GEOS)



Combustion (Nek5000)

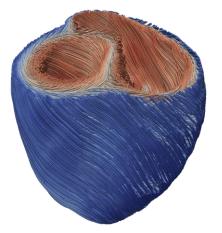


We are interested in working with other applications!

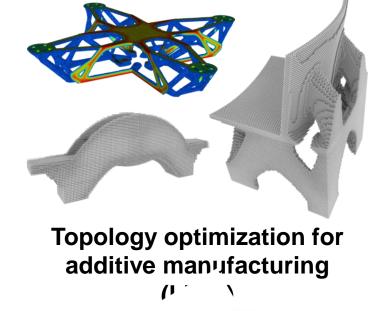


Additional Application Collaborations

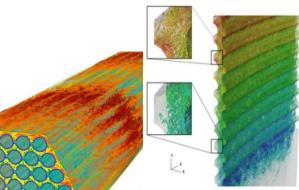


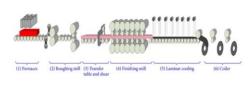


Heart Modelling (Cardioid)

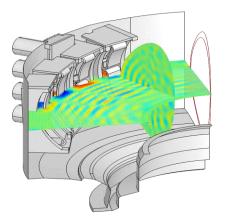




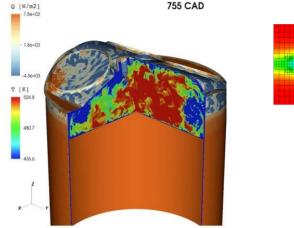


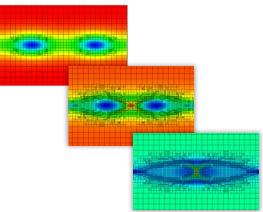






Hot strip mill slab Core-Edge tokamak EM modeling (U. S. Steel) wave propagation (SciDAC



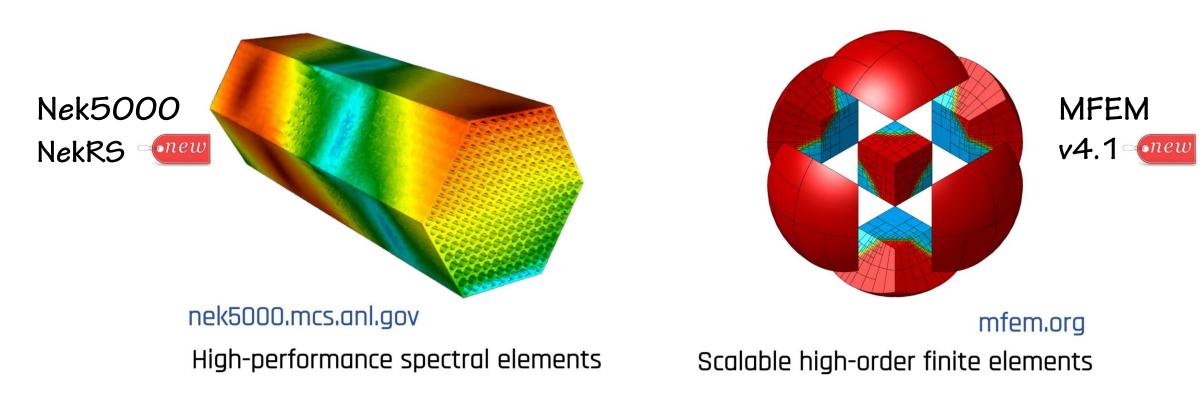


Electric aircraft design Reactor simulation (DOE NEAMSEngine simulation (DOE VTO)Adaptive MHD island coalescence (SciDAC)





- better exploit the hardware to deliver significant performance gain over conventional methods
- ✓ based on MFEM/Nek, low & high-level APIs





CEED Miniapps



ceed.exascaleproject.org/miniapps

- Nekbone / NekBench (Nek5000) new
 - A lightweight subset of Nek5000; solves a standard Poisson equations; weak-scaled to 6 million MPI ranks. Currently support OpenACC/CUDA-based GPU variants.
- libParanumal
 - An experimental testbed for multi-level parallel implementations of high-order finite element computations; under development.
- Laghos (MARBL) anew
 - A proxy for the Lagrangian component of MARBL; solves the time-dependent Euler equation of compressible gas; makes use of unstructured moving meshes.
- Remhos (MARBL)
 - A proxy the Eulerian component of the MARBL; solves the pure advection equations that are used to perform monotonic and conservative discontinuous field interpolation (remap) in ALE methods.
- ExaConstit (ExaAM)
 - A miniapp for the ExaAM project based on MFEM evaluating constitutive material properties at continuum scale.
- HPGMG-FE

✓ useful for vendor engagements, collaboration ✓ part of CORAL-2, ECP, ASC proxies



libParanumal



github.com/paranumal/libparanumal

ECP Apps	Flow-apps	Time Stepping	Spatial Discretization	Algorithmic Acceleration	Core	External Libraries
NekRS —	Incompressible Navier-Stokes	Implicit- explicit	Discontinuous Galerkin	Heterogeneous hybrid multigrid	Iterative solvers	 AMG hypre
MFEM	Oseen	Semi- Lagrangian	Continuous Galerkin	Krylov Recycling	OCCA kernels	 Portability OCCA
libCEED	Stokes	JFNK	Curvilinear elements	RHS projection methods	Parallel mesh wrangling	 Partitioning parRSB
	Compressible Navier-Stokes	Explicit	High-order Elements	Adaptive time stepping	Gather-scatter ops	 GatherScatter gslib
	Galerkin- Boltzmann	Semi-analytic		Spatial adaptivity	Async halo exchanges	 Comms MPI

✓ libParanumal = *reference* library of highly optimized GPU implementations of high-order finite element and discontinuous Galerkin based PDE solvers.

✓ Developed by Tim Warburton's group at Virginia Tech









github.com/ceed/laghos

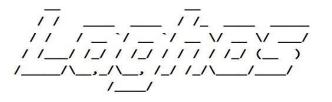
- ✓ Miniapp for HO compressible shock hydrodynamics
 - moving (high-order) curved meshes
 - explicit time integration
- ✓ Proxy for LLNL's Blast code
- ✓ Based on MFEM
 - quick to prototype, C++
 - inherits/motivates performance improvements

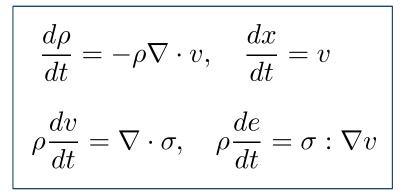
✓ Laghos-3.0: device support based on MFEM-4.0

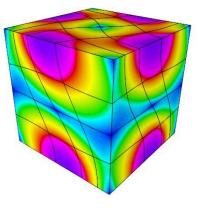
- ✓ Procurement benchmark for CTS-2 at LLNL
- ✓ Used for EI Capitan's node architecture decision

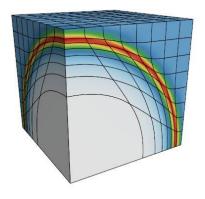
✓ Strong collaboration with NVIDIA

- Summit on Summit meetings
- Optimizing the Laghos-2.0 CUDA version









3D Taylor-Green smooth test problem

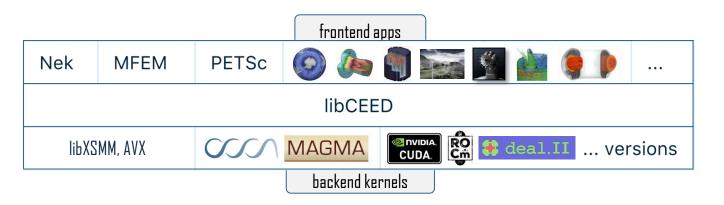
3D Sedov blast shock test problem



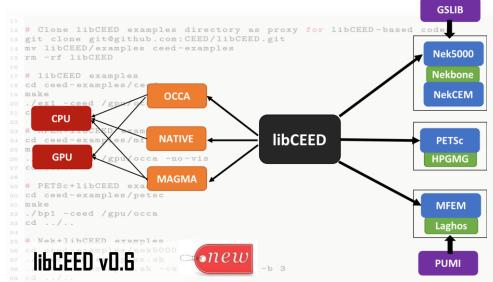
libCEED: CEED's Low-Level API Library



lightweight, portable & performant high-order operator evaluation
github.com/ceed/libceed



- ✓ API between *frontend apps* and *backend kernels*
- ✓ *Efficient operator description* (not global matrix)
- ✓ Clients use any backend as a run-time option
- ✓ Backend can be added as plugins without recompiling
- ✓ Backends compete for best performance, latency vs throughput, optimize for order/device, use JIT, ...



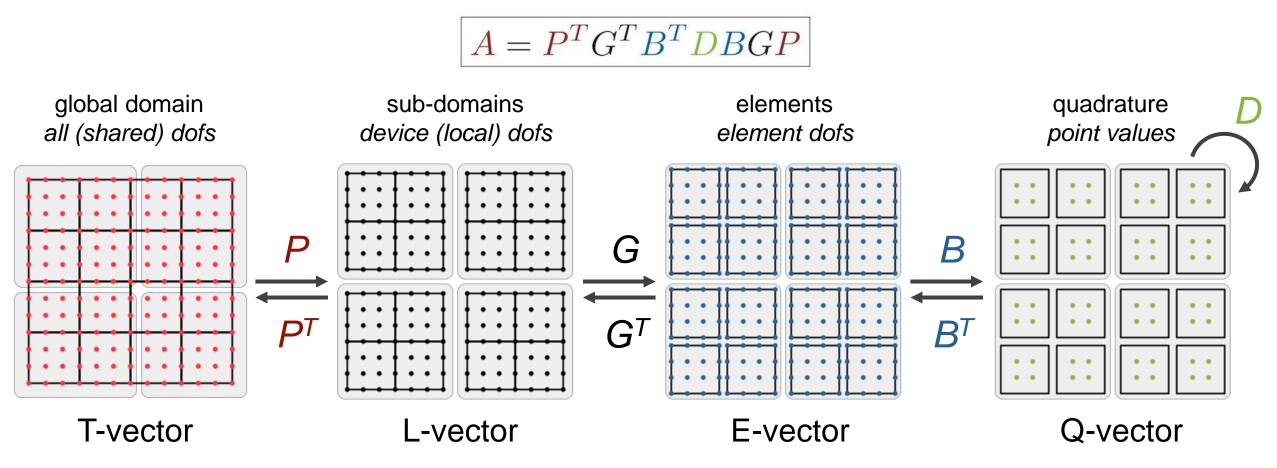
- ✓ Extensible backends
- **CPU**: reference, vectorized, libXSMM
- CUDA using NVRTC cuda-gen
- OCCA (JIT): CPU, OpenMP, OpenCL, CUDA
- MAGMA



FEM Operator Decomposition



FEM operator assembly/evaluation can be split into parallel, mesh, basis, and geometry/physics parts:



 \checkmark partial assembly = store only D, evaluate B (tensor-product structure)

 \checkmark better representation than A: optimal memory, near-optimal FLOPs

 \checkmark purely algebraic

 \checkmark applicable to many apps



CEED benchmarks

github.com/ceed/benchmarks



✓ CEED's *bake-off problems* (BPs) are high-order kernels/benchmarks designed to test and compare the performance of high-order codes.

BP1: Solve {Mu=f}, where {M} is the mass matrix, q=p+2

BP2: Solve the vector system {Mui=fi} with {M} from BP1, q=p+2

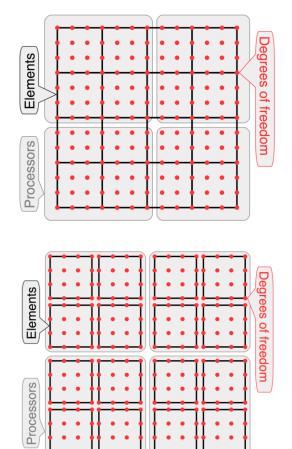
BP3: Solve {Au=f}, where {A} is the Poisson operator, q=p+2

BP4: Solve the vector system {Aui=fi} with {A} from BP3, q=p+2

BP5: Solve {Au=f}, where {A} is the Poisson operator, q=p+1

BP6: Solve the vector system {Aui=fi} with {A} from BP3, q=p+1

- Mixture of compute-intensive + nearest-neighbor communication + vector reductions
- ✓ Compared Nek, MFEM, deal.ii on BG/Q, KNLs, GPUs.
- ✓ Goal is to learn from each other, benefit all HO applications

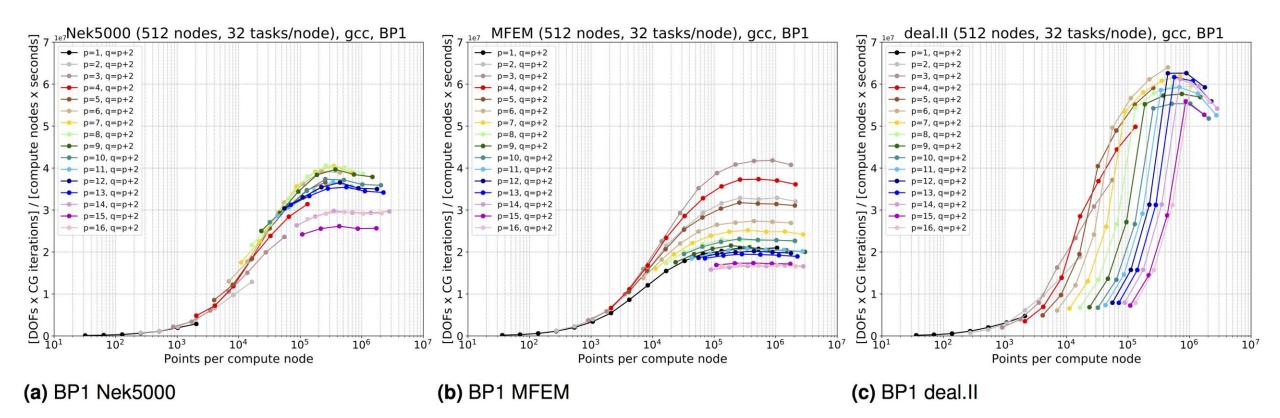


BP terminology: T- and E-vectors of HO dofs



CEED Bake-off Problem 1 on CPU





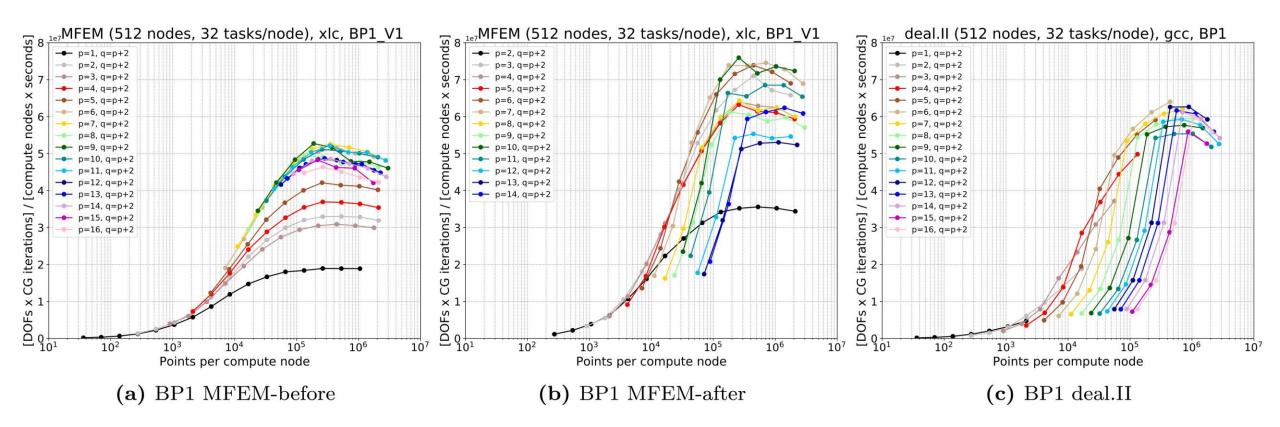
✓ All runs done on BG/Q (for repeatability), 16384 MPI ranks. Order p = 1, ..., 16; quad. points q = p + 2.

- ✓ BP1 results of Nek (left), MFEM (center), and deal.ii (right) on all using gcc compiler BG/Q.
- ✓ Paper: "Scalability of High-Performance PDE Solvers"
- ✓ deal.ii results from Martin Kronbichler: github.com/kronbichler/ceed_benchmarks_dealii



CEED Bake-off Problem 1 on CPU



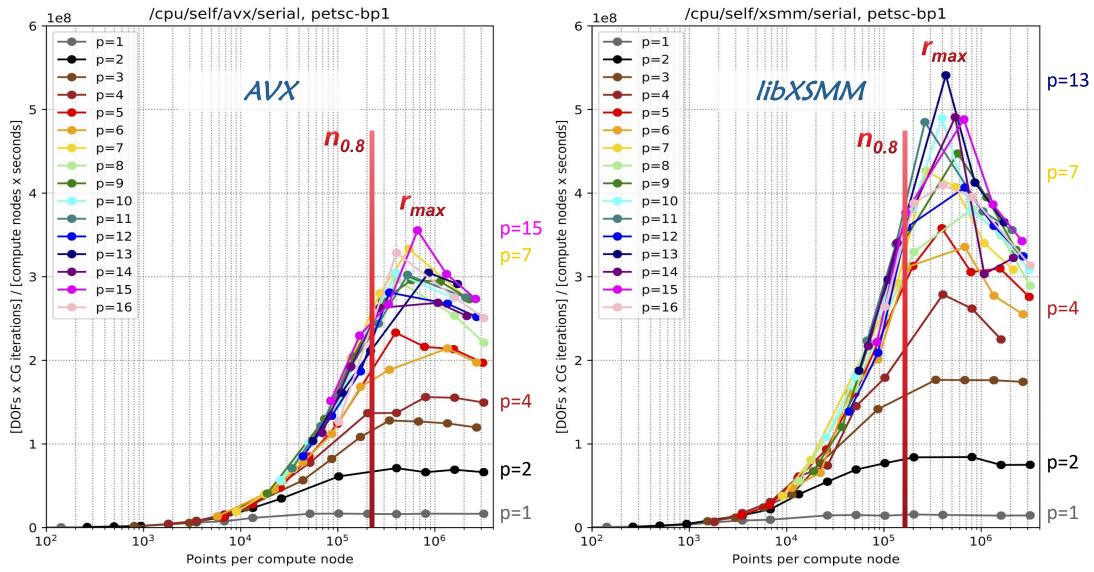


- ✓ All runs done on BG/Q (for repeatability), 16384 MPI ranks. Order p = 1, ..., 16; quad. points q = p + 2.
- ✓ BP1 results of MFEM+xlc (left), MFEM+xlc+intrinsics (center), and deal.ii + gcc (right) on BG/Q.
- ✓ Paper: "Scalability of High-Performance PDE Solvers"
- \checkmark Cooperation/collaboration is what makes the bake-offs rewarding.



BP1/CPU: AVX + libXSMM backends

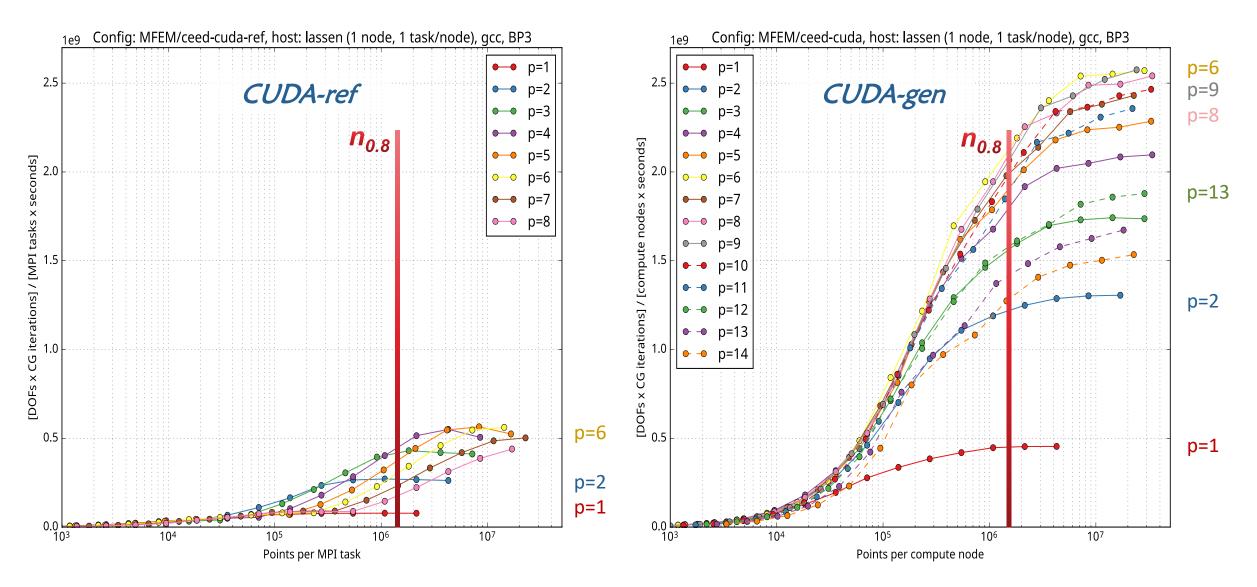




PETSc-BP1, 3D, Intel Xeon E5-2680 v3, 24 cores/node (Haswell)







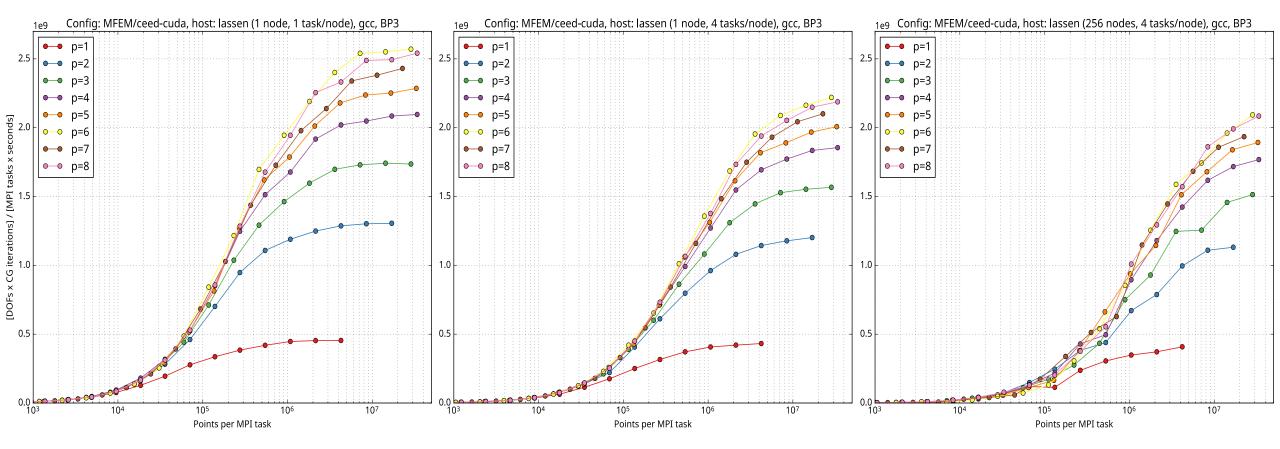
MFEM-BP3, 3D, Lassen 4 x V100 GPUs / node, n_{0.8} about 7.5x larger than Haswell



MFEM performance on multiple GPUs



MFEM-BP3, 3D, Lassen 4 x V100 GPUs / node



1 GPU

4 GPUs

1024 GPUs

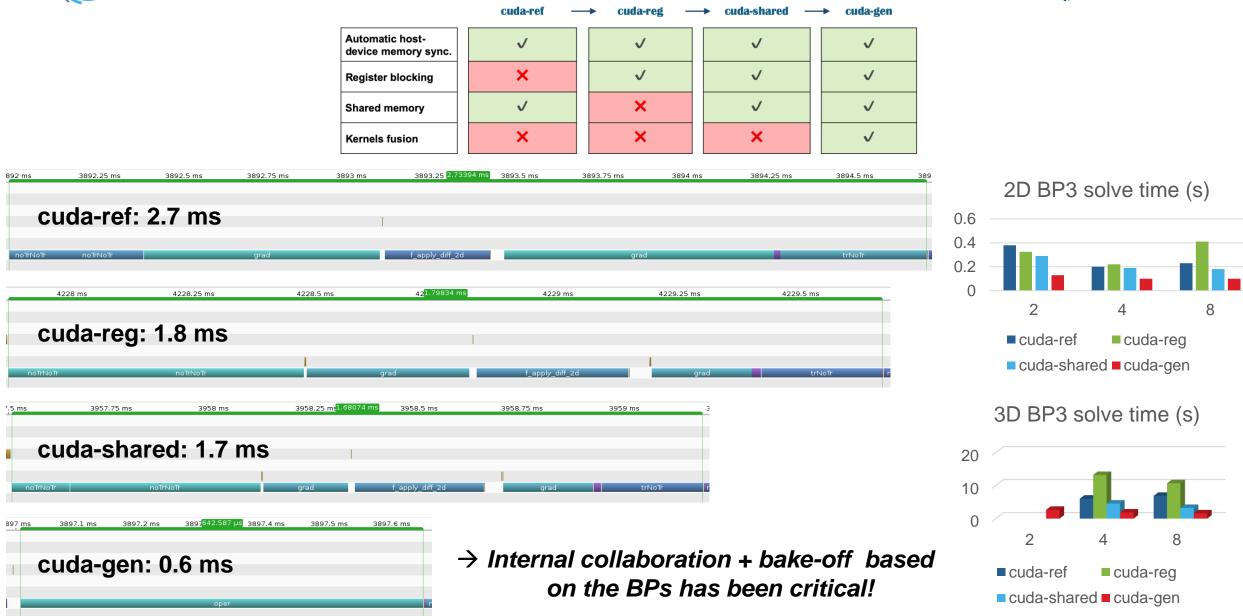
Optimized kernels for MPI buffer packing/unpacking on the GPU GPU-aware MPI ready

Best total performance: **2.1 TDOF/s** Largest size: 34 billion



GPU backend performance evolution



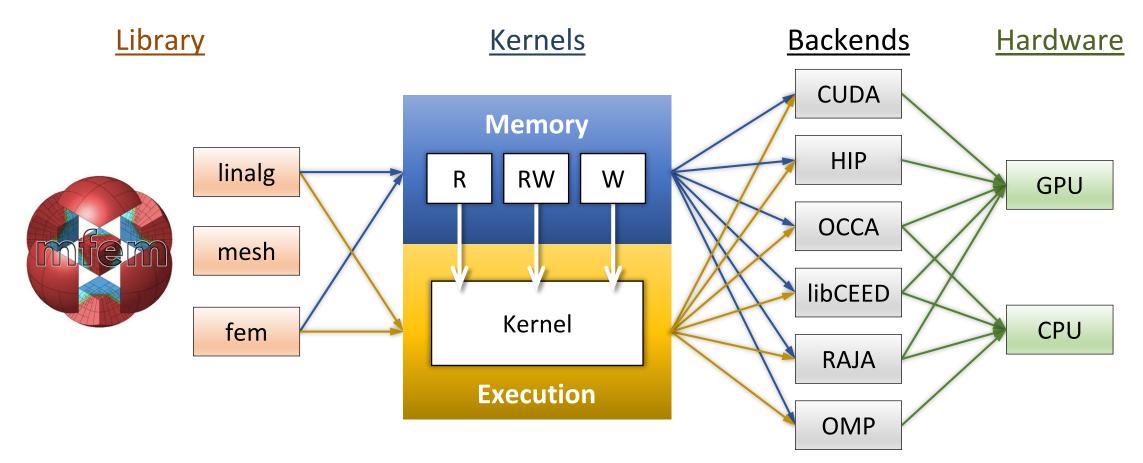




Device support in MFEM-4.0



MFEM-4.0 adds initial GPU support in many linear algebra and finite element operations



✓ Kernels can be specified via loop-body lambda-capture, or raw CUDA, OCCA; many have single source

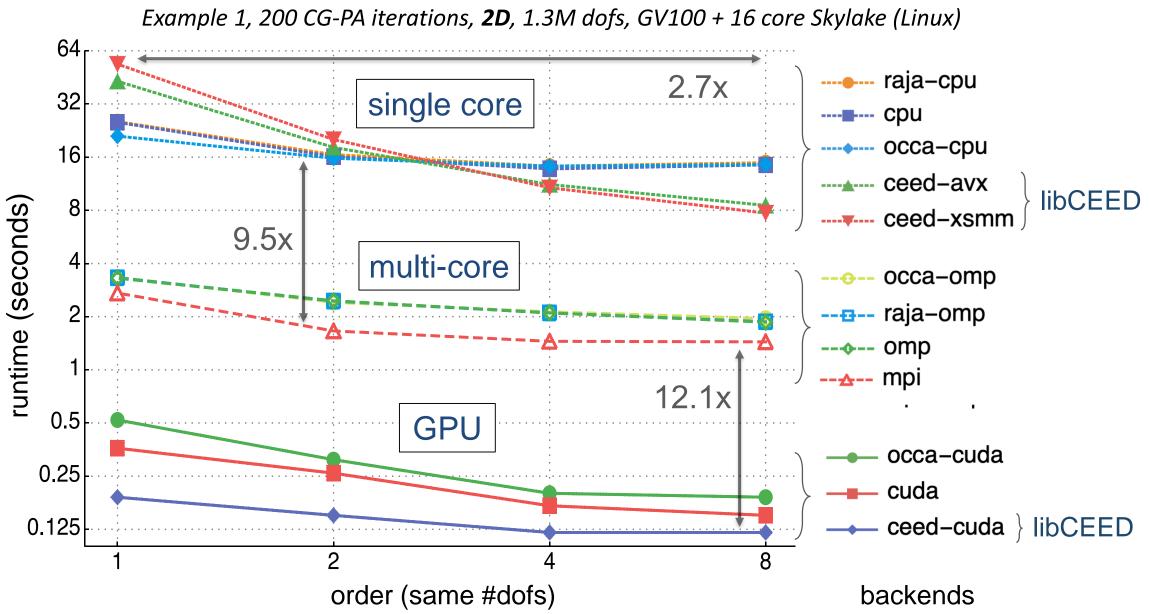
✓ Backends are runtime selectable, can be mixed

✓ Recent additions: support for AMD/HIP



Initial results with MFEM-4.0



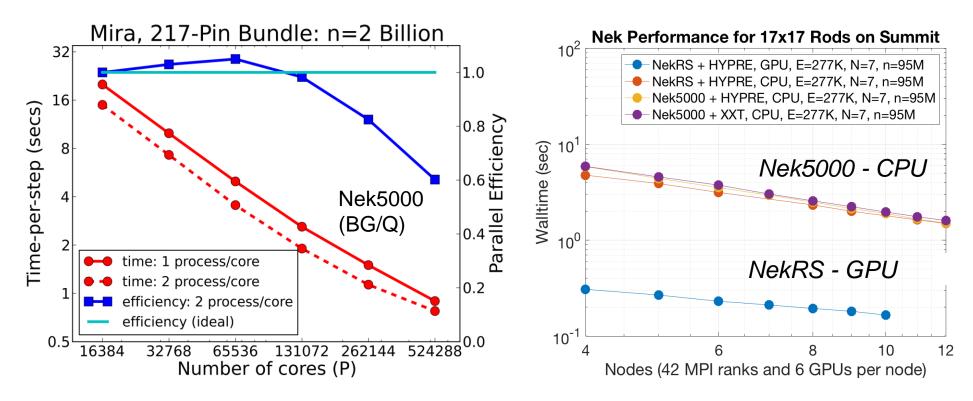


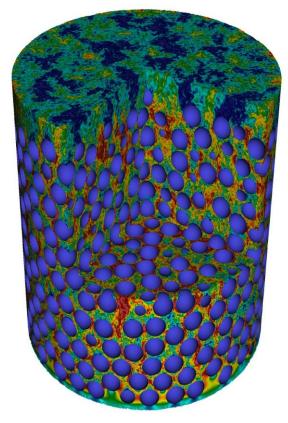


NekRS: GPU-oriented version of Nek5000



- Nek5000 strong scales (2000 pts/rank) to > 1 million cores (Gordon Bell winner)
- NekRS based on OCCA + libParanumal (Warburton et al., V. Tech.)
 - Using GPUs, NekRS is about 10-15x faster than all-CPU code on Summit
 - Main kernels get about 2 TFLOPS on Nvidia V100 (FP64)
 - Principal kernels have been tested on AMD and Intel Gen9



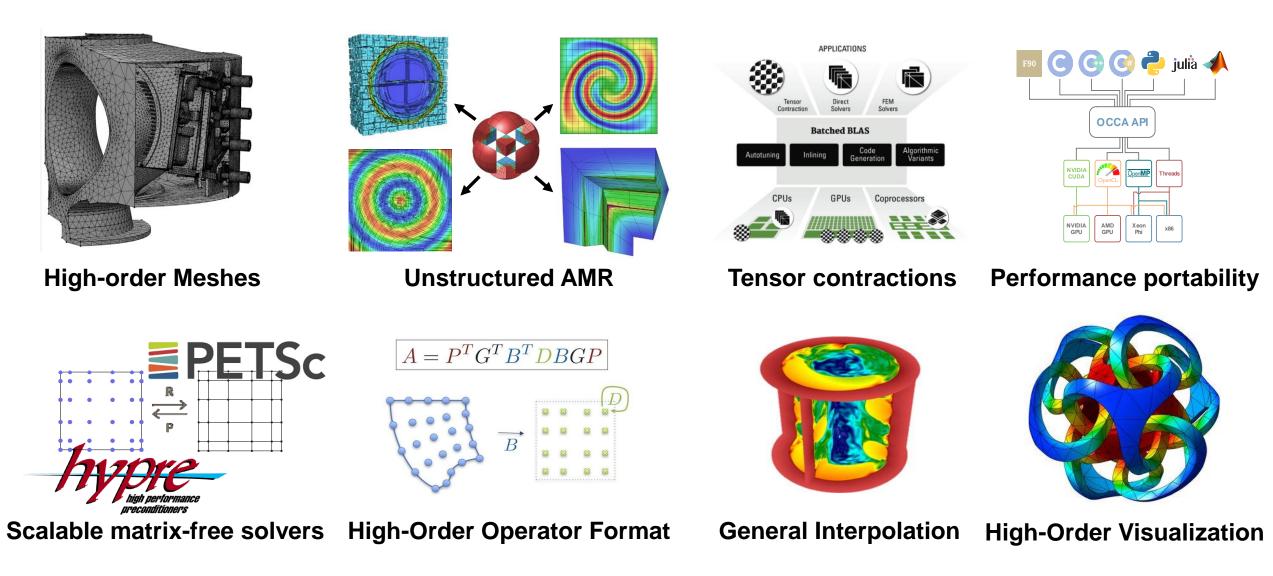


NekRS turbulence simulation for pebble-bed reactor using 66 GPUs on Summit



High-Order Software Ecosystem





More info at: <u>http://ceed.exascaleproject.org/fe</u>



CEED Resources



First annual meeting to be

CEED to participate in GPU

Workshop on batched BLAS

Software release: MFEM v3.3

CEED co-design center

U.S. Department of Energy Exascale Computing Project

held at LLNL

announced

More updates.

ECP Co-Design

R&D Thrusts

7 Application

nackaton at BNL

Website: <u>http://ceed.exascaleproject.org</u>

• Software:

https://github.com/ceed

- Publications: <u>https://ceed.exascaleproject.org/pubs</u>
- ECP:

https://confluence.exascaleproject.org/display/CEED

- Email: <u>ceed-support@llnl.gov</u>
- Applications
 - Misun Min
 - Elia Merzari
 - Vladimir Tomov
 - Robert Rieben

- Sofware
 - Jed Brown
 - Tim Warburton
 - Mark Shephard
 - David Medina

- Hardware
 - Stan Tomov
 - Jean-Sylvain Camier
 - Ian Karlin
 - Scott Parker

- Finite Elements
 - Veselin Dobrev
 - Paul Fischer
 - Tzanio Kolev
 - Panayot Vassilevski



Learn from and educate hardware vendors and software technologies projects about efficient finite element algorithms through CEED developed proxies and miniapps.

 Provide an efficient and user-friendly unstructured PDE discretization component for the future exascale software ecosystem.

CEED is a research partnership involving 30+ computational scientists from two DOE labs and five universities, including members of the Nels000, MFEM, MAGMA, OCCA and PETSC projects. Building on these efforts, CEED will produce a range of software products, collaborating in four interconnected R&D thrusts.

The center is focused on the following computational motifs and their performance on exascale hardware. You can reach the CEED team by emailing ceed-users@llnl.gov or by leaving a comment in the CEED user forum.

PDE-BASED SIMULATIONS ON UNSTRUCTURED GRIDS

CEED will support general finite element algorithms on triangular, quadrilateral, tetrahedral and hexahedral meshes in 10, 20 and 30. We target the whole de Rham complex: H1, H(cur), H(div) and L2/DG spaces and discretizations, as well as conforming and non-conforming unstructured adaptive mesh refinement (AMR). The CEED software will also include optimized assembly support for low-order methods.

Lawrence Livermore National Laboratory

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